



Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	Ι _D T _A = +25°C
-60V	$105m\Omega @ V_{GS} = -10V$	-3.3A
	130mΩ @ V _{GS} = -4.5V	-3.0A

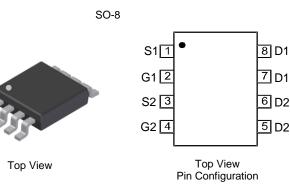
Description

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$, yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Backlighting

Pin1



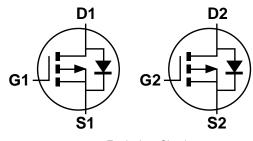
P-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

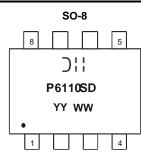
	Part Number	Case	Packaging
	DMP6110SSD-13	SO-8	2,500/Tape & Reel
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.			

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



) | | = Manufacturer's Marking P6110SD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 16 = 2016) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	-60	V	
Gate-Source Voltage	V _{GSS}	±20	V	
	T _C = +25°C T _C = +70°C	Ι _D	-7.8 -6.3	А
Continuous Drain Current (Note 6) $V_{GS} = -10V$	T _A = +25°C T _A = +70°C	Ι _D	-3.3 -2.7	А
Pulsed Drain Current (380µs Pulse, 1% Duty Cycle)	I _{DM}	-24	A	
Maximum Continuous Body Diode Forward Current (Note 6)	IS	-1.8	А	
Avalanche Current (Note 9) L = 0.1mH	I _{AS}	-19	A	
Avalanche Energy (Note 9) L = 0.1mH		E _{AS}	18	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 5 & 7)	T _A = +25°C		1.2	W	
Total Power Dissipation (Note 5 & 7)	T _A = +70°C	PD	0.9		
Total Power Dissipation (Note 5 & 8)	T _A = +25°C		1.2		
Thermal Resistance, Junction to Ambient (Note 5 & 7)	Steady State		104	°C/W	
Thermal Resistance, Junction to Amblent (Note 5 & 7)	t<10s	R _{OJA}	45		
Thermal Resistance, Junction to Ambient (Note 5 & 8)	Steady State		100		
Total Power Dissipation (Note 6 & 7)	T _A = +25°C		1.7	W	
	T _A = +70°C	PD	1.1		
Total Power Dissipation (Note 6 & 8)	T _A = +25°C		1.8		
Thermal Desistance, Junction to Ambient (Note 6.8.7)	Steady State		74	°C/W	
Thermal Resistance, Junction to Ambient (Note 6 & 7)	t<10s	R _{OJA}	37		
Thermal Resistance, Junction to Ambient (Note 6 & 8)	Steady State		71		
Thermal Resistance, Junction to Case (Note 6 & 7)		R _{OJC}	15		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. For a dual device with one active die.

8. For a device with two active die running at equal power. 9. Ias and Eas rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

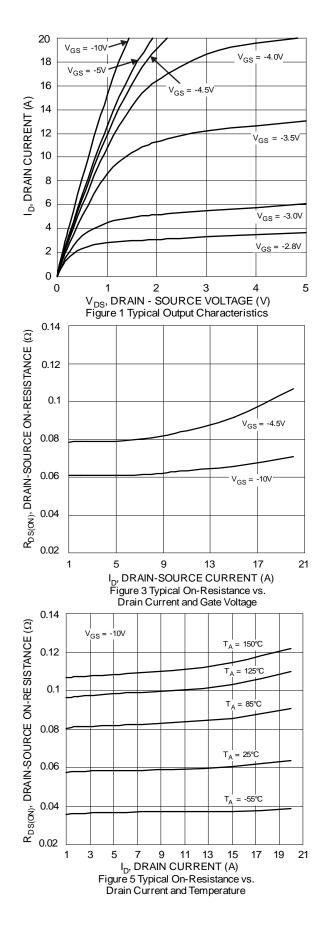


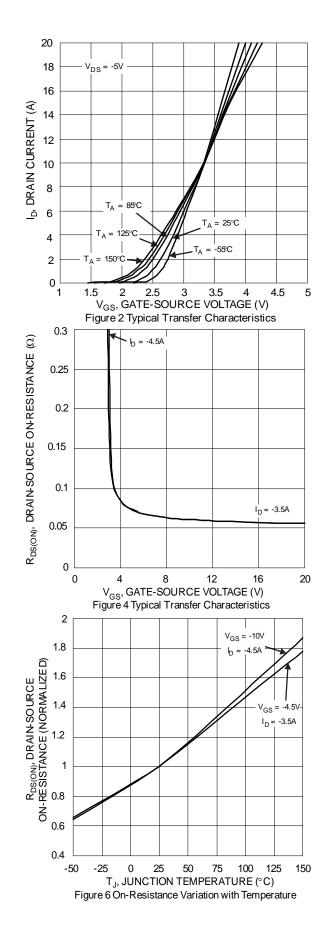
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

			_				
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 10)			r			1	
Drain-Source Breakdown Voltage	BV _{DSS}	-60	—	—	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS		—	-1	μA	$V_{DS} = -48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	—	100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 10)		-					
Gate Threshold Voltage	V _{GS(TH)}	-1	—	-3	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Desser		—	105	mΩ	$V_{GS} = -10V, I_D = -4.5A$	
	R _{DS(ON)}	_	_	130	11152	$V_{GS} = -4.5V, I_D = -3.5A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 11)							
Input Capacitance	C _{ISS}	_	969		pF		
Output Capacitance	Coss		57		pF	VDS = -30V, VGS = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{RSS}	—	44	_	pF		
Gate Resistance	R _G	_	13.7	_	Ω	VDS = 0V, VGS = 0V, f = 1.0MHz	
Total Gate Charge (V _{GS} = -4.5V)	Q _G	—	8.2	_	nC	VDS = -30V, ID = -12A	
Total Gate Charge (V _{GS} = -10V)	Q _G	_	17.2	_	nC		
Gate-Source Charge	Q _{GS}	_	3.0	_	nC	VDS = -30V, ID = -12A	
Gate-Drain Charge	Q _{GD}	_	3.1	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	4.4		ns		
Turn-On Rise Time	t _R	_	23		ns	V _{GS} = -10V, V _{DS} = -30V, R _{GEN} =	
Turn-Off Delay Time	t _{D(OFF)}	_	34		ns	3Ω, ID=-12A	
Turn-Off Fall Time	tF	_	42		ns		
Body Diode Reverse Recovery Time	t _{RR}	_	13.2		ns		
Body Diode Reverse Recovery Charge	Q _{RR}		6.18		nC	-I _S = -12Α, di/dt = 100Α/μs	

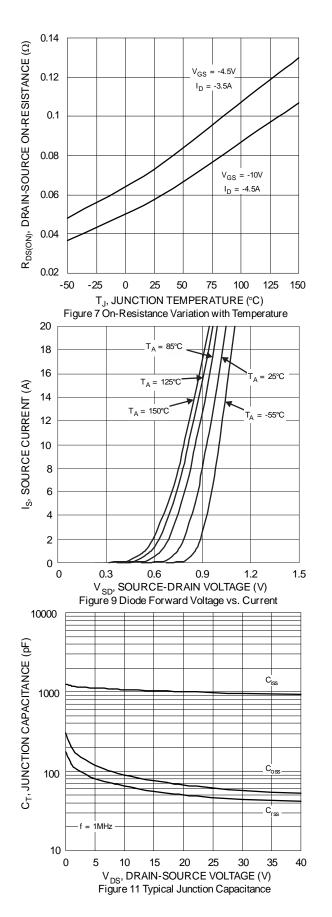
 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:

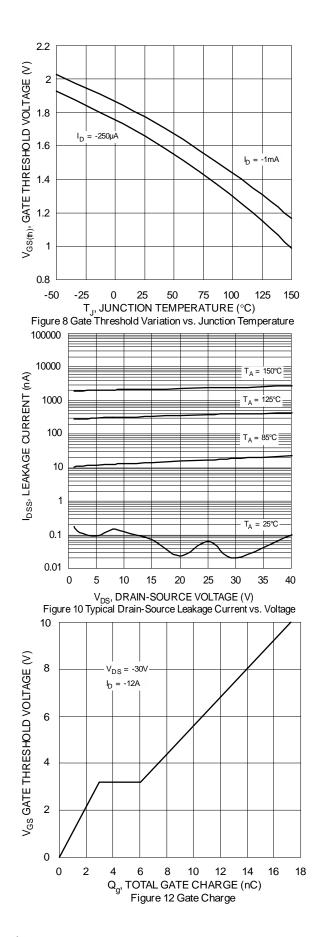




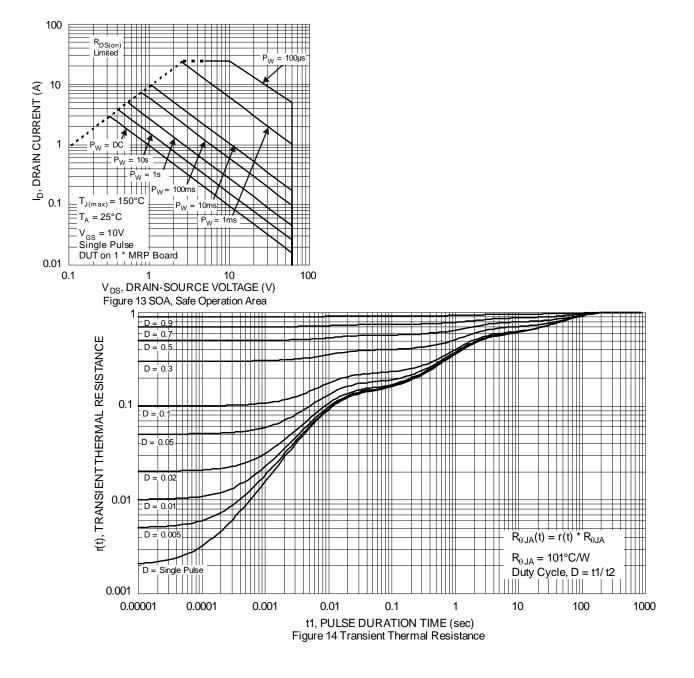








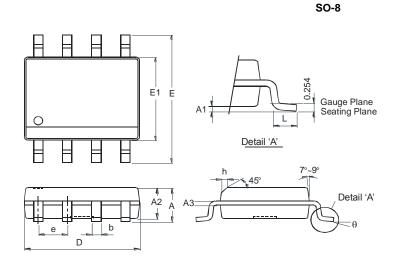






Package Outline Dimensions

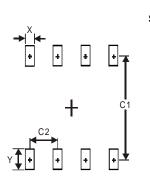
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85 3.95				
е	1.27 Typ				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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